

SPECIFICATIONS

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SAMPLE VERSION	01
SPECIFICATIONS EDITION	004
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PACKAGING NO. (Ver.)	PKG-PE12864LRF-028-H-Q_002



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□ Preliminary specification for design input

Specification for sample approval

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RECORDS OF REVISION

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POWERTIP

1. SPECIFICATIONS

1.1 Features

Item	Standard Value
Display Type	128 * 64 Dots
LCD Type	FSTN, Positive, Transflective
Driver Condition	LCD Module: 1/65 Duty, 1/9 Bias
Viewing Direction	6 O'clock
Backlight	LED B/L
Weight	32 g
Interface	Serial Peripheral Interface
Controller IC	Solomon SSD1805Z
	THIS PRODUCT CONFORMS THE ROHS OF PTC
ROHS	Detail information please refer web side :
	http://www.powertip.com.tw/news.php?area id view=1085560481/

1.2 Mechanical Specifications

Item	Standard Value	
Outline Dimension	74.5 (L) * 57.2 (w) * 9.32(H)	
Viewing Area	63.0 (L) * 40.0 (w)	
Active Area	57.57 (L) * 34.12 (w)	
Dot Size	0.42 (L) * 0.42 (w)	mm
Dot Pitch	0.45 (L) * 0.45 (w)	mm

Note : For detailed information please refer to LCM drawing

1.3 Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Max.	Unit
Power Supp <mark>ly Voltag</mark> e	$V_{DD}-V_{SS}$	_	-0.3	+4.0	V
LCD Driver S <mark>upply Vol</mark> tage	Vop	_	0	+15.0	V
Input Voltage	V _{IN}	_	VSS-0.3	4.0	V
Operating Temperature	T _{OP}	_	-5	50	°C
Storage Temperature.	T _{ST}	_	-20	70	°C
Storage Humidity	H_{D}	Ta<40 ℃	20	90	%RH



1.4 DC Electrical Characteristics

 V_{DD} = 3.3V±0.3V \cdot V_{SS} = 0V \cdot Ta = 25 $^\circ\!\!\mathrm{C}$

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Logic Supply Voltage	V _{DD}	-	3.0	3.3	3.6	V
"H" Input Voltage	V _{IH}	-	$0.8 V_{DD}$	ŀ	V _{DD}	V
"L" Input Voltage	V _{IL}	-	0	-	$0.2 V_{\text{DD}}$	V
"H" Output Voltage	V _{OH}	IVOUT = -100uA	$0.9 V_{DD}$	-	V _{DD}	V
"L" Output Voltage	V _{OL}	IVOUT = 100uA	0	-	0.1 V _{DD}	V
Supply Current		V _{DD} = 3.3 V;V _{OP} = 9.1 V; Pattern= Full display	_	0.5	_	mA
Supply Current	IDD	V _{DD} = 3.3 V;V _{OP} = 9.1 V; Pattern= Horizontal line*1	_	1.5	5	mA
		-5°C	9.2	9.4	9.6	
LCM Driver Voltage	Vop	25 ℃*2	8.9	9.1	9.3	V
		50 ℃	8.7	8.9	9.1	

NOTE: *1 The Maximum current display;

*2 The Vop test point is Vour-Vss.



1.5 Optical Characteristics

LCD Panel: 1/65 Duty, 1/9 Bias, V_{OP} = 9.38 V, Ta = 25°C

Item	Symbol	Conditions	Min.	Тур.	Max.	Reference
View Angle	θ	C <u>≥</u> 2.0, ∅ = 0°	-40°	-	40°	Notes 1 & 2
Contrast Ratio	CR	$\theta = 5^{\circ}, \emptyset = 0^{\circ}$	2	4	-	Note 3
Response Time(rise)	Tr	θ = 5°, \emptyset = 0°	-	100 ms	150 ms	Note 4
Response Time(fall)	Tf	$\theta = 5^{\circ}, \varnothing = 0^{\circ}$	-	200 ms	300 ms	NOLE 4



Note 1: Definition of angles θ and \emptyset





1.6 Backlight Characteristics

LCD Module with LED

Maximum Ratings

Item	Symbol	Conditions	Min.	Max.	Unit
Forward Current	I _F	Ta =25°C	-	100	mA
Reverse Voltage	V _R	Ta =25°C		5	V
Power Dissipation	PD	Ta =25℃	-	0.5	W

Electrical / Optical Characteristics

					Ia =	25 °C
Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage	VF	IF= 50 mA	-	3.9	4.2	V
Reverse Current	IR	VR= 3.0V	-	-	10	μA
Average Brightness	IV	IF= 50 mA	10	15	-	cd/m ²
Average Brightness (with LCD)	IV	IF= 50 mA	1	2	-	cd/m ²
Wavelength (With LCD)	Hue	IF= 50 mA	578	583	588	nm
Uniformity *1	∆B	IF= 50 mA	70	-	-	%
Color		Ye	llow-Gree	en		

*1 : △B=(B(min) / B(max))*100%





2. MODULE STRUCTURE

- 2.1 Counter Drawing
 - 2.1.1 LCM Mechanical Diagram
 - * See Appendix
 - 2.1.2 Block Diagram



POWERTIP

2.2 Interface Pin Description

Pin No.	Symbol	Function
1	А	Power supply for LED backlight anode input.
2	К	Power supply for LED backlight cathode input .
		This is the most positive voltage supply pin of the chip. It can be supplied externally or generated by the internal DC-DC
3	Vout	level at VOUT, the voltage level is used for internal referencing only. The voltage level at VOUT pin is not used for driving external circuitry.
4	Vss	The VSS is the ground reference of the system.
5	Vss	The VSS is the ground reference of the system.
6	Vdd	This pin is the system power supply pin of the logic block.
7	SDA	serial data input (D7).
8	SCK	serial clock input (D6).
9	D/C	This pin is Data/Command control pin. When the pin is pulled high, the data at D7 - D0 is treated as display data. When the pin is pulled low, the data at D7 - D0 will be transferred to the command register.
10	/RES	This pin is the reset signal input. Initialization of the chip is started once this pin is pulled low. Minimum pulse width for reset sequence is 20us.
11	/CS1	These pins are the chip select inputs. The chip is enabled for MCU communication only when both CS 1 is pulled low and CS2 is pulled high.



2.3 Timing Characteristics



V_{DD} = 3.3V±0.3V $,~V_{\text{SS}}$ = 0V ,~Ta = 25 $^\circ\!\!\!\mathrm{C}$

Symbol	Parameter	Min	Тур	Max	Unit
t _{cycle}	Clock Cycle Time	58.8	-	-	ns
t _{AS}	Address Setup Time	10	-	-	ns
t _{AH}	Address Hold Time	5	-	-	ns
t _{DSW}	Write Data Setup Time	30	-	-	ns
t _{DHW}	Write Data Hold Time	30	-	-	ns
Tolkl	Clock Low Time	29.4	-	-	ns
Тсцкн	Clock High Time	29.4	-	-	ns
tcss	Chip Select Setup Time (for D7 input)	30	-	-	ns
t _{сsн}	Chip Select Hold Time (for D0 input)	29.4	-	-	ns
t _R	Rise Time	-	-	10	ns
t⊨	Fall Time	-	-	10	ns



2.4 Display Command

Command Table (D/C = 0, R/W (WR) = 0, E=1(RD = 1) unless specific setting is stated)

D/C	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description
0	00 – 0F	0	0	0	0	X3	X ₂	X ₁	Xo	Set Lower Column Address	Set the lower nibble of the column address register using $X_3X_2X_1X_0$ as data bits. The lower nibble of column address is reset to 0000b after POR.
0	10 – 1F	0	0	0	1	X3	X2	X1	Xo	Set Higher Column Address	Set the higher nibble of the column address register using $X_3X_2X_1X_0$ as data bits. The higher nibble of column address is reset to 0000b after POR.
0	20 – 27	0	0	1	0	0	X ₂	X1	Xo	Set Internal Gain Resistor Ratio	Feedback gain of the internal regulated DC-DC converter for generating VOUT increases as $X_2X_1X_0$ increased from 000b to 111b. After POR, $X_2X_1X_0$ = 100b.
0	28 – 2F	0	0	1	0	1	X2	1	Xo	Set Power Control Register	X ₀ =0: turns off the output op-amp buffer (POR) X ₀ =1: turns on the output op-amp buffer X ₂ =0: turns off the internal voltage booster (POR) X ₂ =1: turns on the internal voltage booster
0	40 – 7F	0 *	1 Y6	X ₅ Y ₅	X₄ Y₄	X ₃ Y ₃	X ₂ Y ₂	X ₁ Y ₁	X ₀ Y ₀	Set Display Start Line	For 68 MUX mode, set $X_5X_4X_3X_2X_1X_0 = 111111$ and set the GDDRAM display start line register from 0-67 using $Y_6Y_5Y_4Y_3Y_2Y_1Y_0$ For 64/54/32 MUX modes, set GDDRAM display start line register from 0-63 using $X_5X_4X_3X_2X_1X_0$. There is no need to send the $Y_6Y_5Y_4Y_3Y_2Y_1Y_0$ parameters. Display start line register is reset to 000000 after POR for all MUX modes.
0	84 – 87	1	0	0	0	0	1	x ₁	X₀	Set Boost Level	Set the DC-DC multiplying factor from 2X to 5X. X ₁ X ₀ : 00: 3X 01: 4X 10: 5X 11: 2X Remarks: The POR default boosting level is determined by hardware selection pin, B0 & B1.
0 0	81	1 0	0 0	0 X5	0 X4	0 X3	0 X2	0 X1	1 X₀	Set Contrast Control Register	Select contrast level from 64 contrast steps. Contrast increases (VOUT decreases) as X ₅ X ₄ X ₃ X ₂ X ₁ X ₀ is increased from 000000b to 111111b. X ₅ X ₄ X ₃ X ₂ X ₁ X ₀ = 100000b after POR
0	A0 – A1	1	0	1	0	0	0	0	Xo	Set Segment Re- map	X ₀ =0: column address 00h is mapped to SEG0 (POR) X ₀ =1: column address 83h is mapped to SEG0 Refer to Table 5 on page 16 for example.
0	A2 - A3	1	0	1	0	0	0	1	Xo	Set LCD Bias	$X_0=0$: POR default bias: 32 MUX mode = 1/8 54 MUX mode = 1/8 64 MUX mode = 1/9 68 MUX mode = 1/9 $X_0=1$: alternate bias: 32 MUX mode = 1/6 54 MUX mode = 1/6 64 MUX mode = 1/7 68 MUX mode = 1/7 For other bias ratio settings, see "Set 1/4 Bias Ratio" and "Dot bias ratio settings, see "Set 1/4 Bias Ratio"
0	A4 – A5	1	0	1	0	0	1	0	Xo	Set Entire Display On/Off	X ₀ =0: normal display (POR) X ₀ =1: entire display on
0	A6 – A7	1	0	1	0	0	1	1	Xo	Set Normal/Reverse Display	X ₀ =0: normal display (POR) X ₀ =1: reverse display



D/C	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description
0	AE – AF	1	0	1	0	1	1	1	Xo	Set Display	X ₀ =0: turns off LCD panel (POR)
										On/Off	X ₀ =1: turns on LCD panel
0	B0 – B8	1	0	1	1	X3	X2	X ₁	Xo	Set Page Address	Set GDDRAM Page Address (0-8) for read/write using $X_3X_2X_1X_0$
0	C0 – C8	1	1	0	0	X3	*	*	*	Set COM Output	X ₃ =0: normal mode (POR)
										Scan Direction	X ₃ =1: remapped mode,
											COMU to COM [N-1] becomes COM [N-1] to COMU when Multiplex ratio is equal to N
											See Table 5 on page 16 for detail mapping
0	F0	1	1	1	0	0	0	0	0	Set Read-Modify-	Read-Modify-Write mode will be entered in which the
-		·	-		-	-	-	-	-	Write Mode	column address will not be increased during display
											data read. After POR, Read-modify-write mode is
											turned OFF.
0	E2	1	1	1	0	0	0	1	0	Software Reset	Initialize internal status registers.
0	EE	1	1	1	0	1	1	1	0	Set End of Read-	Exit Read-Modify-Write mode. RAM Column address
										Modity-write	Detore entering the mode will be restored. After POR,
0			0	4		4	4	_	v	Indiastor Display	X = 0: indicator off (POP, cocond command buts is not
0	AC - AD	*	*	*	*	*	*	Y.		Mode	required)
Ŭ								.,		inout i	X ₀ = 1: indicator on (second command byte required)
											$Y_1Y_0 = 00$: indicator off
											$Y_1Y_0 = 01$; indicator on and blinking at ~1 second
											Interval $V_{\rm e}V_{\rm e} = 10^{\circ}$ indicator on and blinking at ~1/2 second.
											interval
											$Y_1Y_0 = 11$: indicator on constantly
											This second byte command is required ONLY when
											"Set Indicator On" command is sent.
0	E3	1	1	1	0	0	0	1	1	NOP	Command result in No Operation.
0	F0 – FF	1	1	1	1	*	*	*	*	Set Test Mode	Reserved for IC testing. Do NOT use.
0	AE	1	0	1	0	1	1	1	0	Set Power Save	Either standby or sleep mode will be entered using
0	AS		0	1		1	1	0	Xa	wode	compound commands. Issue compound commands "Set Display Off" followed
Ő		*	*	*	*	*	*	X	Xn		by "Set Entire Display On". Standby mode will be
Ĩ									10		entered when the static indicator is on constantly. Sleep
											mode will be entered when static indicator is off.



Extended Command Table(D/C = 0,R/W (WR) = 0,E=1(RD = 1) unless specific setting is stated)

D/C	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description
0	82	1	0	0	0	0	0	1	0	OTP Setting	X ₃ X ₂ X ₁ X ₀ : OTP fuse value
0		*	0	0	0	X3	X2	Χ1	Xo		0000 : original contrast
											0001 : original contrast + 1 steps
											0010 : original contrast + 2 steps
											0011 : original contrast + 3 steps
											0100 : original contrast + 5 stops
											0110 · original contrast + 6 steps
											0111 : original contrast + 7 steps
											1000 : original contrast - 8 steps
											1001 : original contrast - 7 steps
											1010 : original contrast - 6 steps
											1011 : original contrast - 5 steps
											1100 : original contrast - 4 steps
											1101 : original contrast - 3 steps
											1111 original contrast - 1 stops
0	02	1	0	0	0	0	0	1	1	OTP	This command starts to program LCD driver with OTP
U U	05	'	0	0	0		U			Programming	offset value. Each hit can be programmed to 1 once
										riogramming	Detail of OTP programming procedure on page 31
0	Δ.8	1	0	1	0	1	0	0	0	Set Multiplex	To select multiplex ratio N from 2 to the maximum
ŏ	/10	ò	Xa	X ₅	X	X ₃	x,	X ₁	Xn	Ratio	multiplex ratio (POR value) for each member (including
		-				.~		,			icon line for 65 MUX mode).
											Max. MUX ratio:
											68 MUX: 68
											$N = X_6X_5X_4X_3X_2X_1X_0 + 1 + ICON^*$, (*ICON exist for
											64/54/32 MUX mode)
		_	_		_						e.g. N = 0011110 + 2 = 17
0	A9	1	0	1	0	1	0	0		Set Blas Ratio	MUX $X_1X_0 = 00$ 01 10 11
U		X7	X6	X5	X4	X3	X2	X1	Xo	Set TC value	32 : 1/8 of 1/6(POR) 1/6 of 1/5 1/9 of 1/7 P
										Fred	64: 1/8 or 1/6 1/6 or 1/5 1/9 or 1/7/POR) P
										ricų.	68: 1/8 or 1/6 1/6 or 1/5 1/9 or 1/7 (POR) P
											P stands for prohibited settings
											X ₄ X ₃ X ₂ = 000: (TC0) Typ0.05 (POR)
											X ₄ X ₃ X ₂ = 010: (TC2) Typ0.15
											$X_4X_3X_2 = 100$; (1C4) Typ0.20
											X ₄ X ₃ X ₂ = 111: (TC7) Typ0.25
											Increase the value of X ₇ X ₆ X ₇ will increase the oscillator
											frequency and vice versa
											Default Mode:
											X ₇ X ₆ X ₅ Osc Frequency (Hz)
											000 61
											001 64
											010 68
											100 75
											101 80
											110 90
											111 98
											Remarks: By software program the multiplex ratio, the
											typical oscillator frequency is listed above.
0	AA – AB	1	0	1	0	1	0	1	Xo		X ₀ = 0: use normal setting (POR)
										Set ¼ Bias Ratio	X ₀ = 1: fixed at 1/4 bias regardless of other bias setting
											commands



D/C	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description
0	D0 – D1	1	1	0	1	0	0	0	Xo	Set icon enabled	X ₀ = 0: icon is off. X ₀ = 1: icon is on. (POR)
0	D3	10	1 X ₅	0 X ₅	1 X_4	0 X ₃	0 X ₂	1 X ₁	1 X ₀	Set Display Offset Set Total Frame Phases	After POR, $X_6X_5X_4X_3X_2X_1X_0 = 0$ After setting MUX ratio less than default value, data will be displayed at the beginning/towards the end of display matrix. To move display towards Row 0 by L, $X_6X_5X_4X_3X_2X_1X_0$ = L To move display away from Row 0 by L, $X_6X_5X_4X_3X_2X_1X_0 = Y$ -L Note: max. value of L = POR default MUX ratio – display MUX Note: Y represents POR default MUX ratio The On/Off of the Static Icon is given by 3 phases / 1 phase overlapping of the M and MSTAT signals. This command set total phases of the M/MSTAT signals for each frame. The more the total phases, the less the overlapping time and thus the lower the effective driving voltage. $X_5X_4 = 00: 5$ phases $X_5X_4 = 10: 9$ phases (POR) $X_5X_4 = 11: 16$ phases
0	D4	1	1	0 X5	1 X4	0	1 0	0	0 0	Set Display Offset	After POR, $X_6X_5X_4X_3X_2X_1X_0 = 0$ After setting MUX ratio less than default value, data will be displayed at the beginning/towards the end of display matrix. To move display towards Row 0 by L, $X_6X_5X_4X_3X_2X_1X_0$ = L To move display away from Row 0 by L, $X_6X_5X_4X_3X_2X_1X_0 = Y-L$ Note: max. value of L = POR default MUX ratio – display MUX Note: Y represents POR default MUX ratio

Read Command Table (D/C = 1, R/W (WR) = 1, E=1(RD = 0) unless specific setting is stated)

D/C	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description
1	00 - FF	X ₇	X	X5	0	X3	X ₂	X1	Xa	Status Register Read	$\begin{array}{llllllllllllllllllllllllllllllllllll$



3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart





Item	Customer	Sales	R&D	Q.A	Manufact uring	Product control	Purchase	Inventory control			
Sales Service	Info	Claim	[Trackin	Failure an Corrective	action					
Q.A Activity	1. ISO 900 3. Equipme 5. Standard	1 Maintena ent calibrati dization Ma	ance Activi ion inagement	<i>v</i> ities 2. Process improvement proposal 4. Education And Training Activities							



3.2. Inspection Specification

Scope : The document shall be applied to LCD Module for Monotype and Color STN(Ver, B01).

igoplusInspection Standard : MIL-STD-105E Table Normal Inspection Single Sampling Level $I\!I$.

◆Equipment : Gauge、MIL-STD、Powertip Tester、Sample

◆Defect Level : Major Defect AQL : 0.4 ; Minor Defect : AQL : 1.5.

OUT Going Defect Level : Sampling .

◆Manner of appearance test :

- (1). The test be under 20W×2 fluorescent light ' and distance of view must be at 30 cm.
- (2). Standard of inspection : (Unit : mm)
- (3). The test direction is base on about around 45° of vertical line. (Fig. 1)
- (4). Definition of area . (Fig. 2)



B area : Outside of viewing area



♦ Specification:

NO	Item	Criterion	Level
		1. 1 The part number is inconsistent with work order of Production.	Major
01	Product condition	1.2 Mixed production types.	Major
		1.3 Assembled in inverse direction.	Major
02	Quantity	2. 1 The quantity is inconsistent with work order of production.	Major
03	Outline dimension	3.1 Product dimension and structure must conform to Structure diagram.	Major
		4. 1 Missing line character and icon.	Major
		4. 2 No function or no display.	Major
04	Electrical Testing	4. 3 Output data is error.	Major
		4. 4 LCD viewing angle defect.	Major
		4.5 Current consumption exceeds product specifications.	Major



♦Spe	ecification For Mono	type and Color	stn :					(Ver. B01)
NO	Item		C	riteri	n			Level
	Black or white dot 、scratch 、 contamination	5. 1 Round tyj 5. 1. 1 displa • White an 4 white o • Densely s	pe: ny only : d black spots on or black spots pr paced : NO mor	displa esent. e than	ny ≤ 0. 30 mm two spots or l	n , no ines v	more than vithin 3 mm	
		5. 1. 2 Non-d	lisplay :					
	Bound trme	Din	nension		Acceptance	(Q'ty	7)	
	Kound type	(dian	heter: Ψ)		A area	В	area	
	→ x ←		$\Phi \leq 0.10$	Acce	ept no dense			
05	<u>Y</u>	0.10 <	$\Phi \leq 0.20$		3			Minan
05		0.20 <	$\Phi \leq 0.30$		2	1	gnore	MINOF
	Φ=(x+y)/2	Total	l quantity	\sum	4			
		5. 1. 3 Line tự	ype:					
			Dimension		Accep	tance	e (Q'ty)	
	Line type	Length (L)	Width (W)		A area		B area	
	∕ ¥ W		$W \leq 0$	0. 03	Accept no de	nse		
		$L \leq 3.0$	$0.03 < W \leq 0$	0. 05	4		Ignore	
	L	$L \leq 2.5$	$0.05 < W \leq 0.$	075	4			
			W >0	. 075	Ast	round	l type]
		Dim	ension		Acceptano	ce (Q'	'ty)	
		(diame	eter : Φ)		A area		B area	
			$\Phi \leq 0.20$	Ac	cept no dense			
06	Polarizer	0.20 <	$\Phi \leq 0.50$		3			Minor
	Bubble	0.50 <	$\Phi \leq 1.00$		2		Ignore	
			$\Phi > 1.00$		0			
		Total	quantity		4			















♦Speci	ification For Mo	notype and Color STN:	(Ver.B01)			
NO	Item	Criterion	Level			
		8. 1 Backlight can't work normally.	Major			
08	Backlight elements	8. 2 Backlight doesn't light or color is wrong.				
		8. 3 Illumination source flickers when lit.	Major			
		9. 1 Pin type must match type in specification sheet.	Major			
		9. 2 No short circuits in components on PCB or FPC.	Major			
09	General appearance	9. 3 Product packaging must the same as specified on packaging specification sheet.	Minor			
		9. 4 The folding and peeled off in polarizer are not acceptable.	Minor			
		9. 5 The PCB or FPC between B/L assembled distance (PCB or FPC) is ≤1.5 mm.	Minor			



4. RELIABILITY TEST

4.	1 Reliability Test Co	ondition			Ver.B01)
NO.	TEST ITEM		TEST CON	DITION	
1	High Temperature Storage Test	Keep in +70 ±2°C 9 Surrounding temperative	6 hrs ature, then stora	age at normal condition	n 4hrs.
2	Low Temperature Storage Test	Keep in −20 ±2°C 96 Surrounding tempera	hrs hrs, then stor:	age at normal condition	n 4hrs.
3	High Temperature / High Humidity Storage Test	Keep in +60°C / 90% Surrounding tempera (Excluding the polari	R.H duration f ature, then stora izer)	for 96 hrs age at normal condition	n 4hrs.
4	Temperature Cycling Storage Test	-20℃ (30mins) ← Surrounding tempera	$C \rightarrow +25^{\circ}C \rightarrow (5 \text{mins})$ 10 Cy ature, then store	$+70^{\circ}C \rightarrow +25^{\circ}C$ (30mins) (5mins) cle age at normal condition	n 4hrs.
		Air Discharge: Apply 2 KV with 5 ti Discharge for each pe	mes A plarity +/- d	Contact Discharge: Apply 250 V with 5 tim lischarge for each pola	ies rity +/-
5	ESD Test	 Temperature amb Humidity relative Energy Storage C Discharge Resista Discharge, mode Single Discharge (tim (Tolerance if the output) 	biance : $15^{\circ}C \sim 30^{\circ} \sim 60^{\circ}$ capacitance(Cs+ ince(Rd) : $330^{\circ}\Omega$ of operation : ne between suc	35℃ -Cd):150pF±10% 2±10% excessive discharges at cation:±5%)	least 1 sec)
6	Vibration Test (Packaged)	 Sine wave 10~55 The amplitude of Each direction (X) 	Hz frequency vibration :1.5 X \ Y \ Z) durat	(1 min/sweep) mm tion for 2 Hrs	
7	Drop Test (Packaged)	Packing 45. 90 0 Drop Direction : %1	g Weight (Kg) 0 ~ 45.4 4 ~ 90.8 .8 ~ 454 ver 454 corner / 3 edges	Drop Height (cm) 122 76 61 46 / 6 sides each 1time	

POWERTIP

5. PRECAUTION RELATING PRODUCT HANDLING 5.1 SAFETY

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

5.2 HANDLING

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module , be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully ,do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth , as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 Do not apply force on LCD panel.

5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is $25^{\circ}C \pm 5^{\circ}C$ and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush , shake , or jolt the module.

5.4 TERMS OF WARRANTY

5.4.1 Applicable warrant period

The period is within thirteen months since the date of shipping out under normal using and storage conditions.

5.4.2 Unaccepted responsibility

This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.

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7	NEW DRAWING	Add notes	Modify version of LCM	Add FPC description						Pull Tape		▶
EV BY							6.IC NO.:SSD1805 7.LED COLOR:YEL 8.a:P1.4X10=14.C 9.Rubber: Silicon Shin Etsu UL II 10.FPC: QTHD fro EP05 from Ex	5.7 5.7 5.7 5.7 5.7 5.7 1.LCD TYPE:FSTN 2.LCD DISPLAY:PC 3.VIEW DIRECTION 3.VIEW DIRECTION 4.Top: -5~50°C 5.The tolerance u	2-\$1.5			74.5(B/L OL 72.7(Rubber (64.6±0.1(Rubb 63.0(LCD) 57.57(A.)
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